

- Large Bright High Resolution Color Touch Screen
- Built-In Probe Position Encoding Means
- USB, LAN, VGA outputs
- Huge Data Storage Capability
- Longitudinal, Shear, Guided, and Surface Waves
- A-, B-, CB-, C-, D-, P-Scan, and TOFD

TOFD



- Up To 20m Length of One Line Scanning Record
- Playback A-Scans for recorded Images
- Enhanced Signal Evaluation Live and Frozen A-Scans
- Defect Sizing and Pattern Analysis
- Compliance with ASME and RBIM Procedures



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ISONIC 2006 complies with requirements of National and International Codes:

ASME Section I – Rules for Construction of Power Boilers

ASME Section VIII, Division 1 - Rules for Construction of Pressure Vessels

ASME Section VIII, Division 2 - Rules for Construction of Pressure Vessels. Alternative Rules

ASME Section VIII Article KE-3 - Examination of Welds and Acceptance Criteria

ASME Code Case 2235 Rev 9 – Use of Ultrasonic Examination in Lieu of Radiography

Non-Destructive Examination of Welded Joints – Ultrasonic Examination of Welded Joints. – British and European Standard BS EN 1714:1998

Non-Destructive Examination of Welds – Ultrasonic Examination – Characterization of Indications in Welds. – British and European Standard BS EN 1713:1998

Calibration and Setting-Up of the Ultrasonic Time of Flight Diffraction (TOFD) Technique for the Detection, Location

and Sizing of Flaws. - British Standard BS 7706:1993

WI 00121377, Welding – Use Of Time-Of-Flight Diffraction Technique (TOFD) For Testing Of Welds. – European Committee for Standardization – Document # CEN/TC 121/SC 5/WG 2 N 146, issued Feb, 12, 2003

Non-Destructive Testing – Ultrasonic Examination – Part 5: Characterization and Sizing of Discontinuities. – British and European Standard BS EN 583-5:2001

Non-Destructive Testing – Ultrasonic Examination – Part 2: Sensitivity and Range Setting. – British and European Standard BS EN 583-2:2001

Manufacture and Testing of Pressure Vessels. Non-Destructive Testing of Welded Joints. Minimum Requirement for Non-Destructive Testing Methods – Appendix 1 to AD-Merkblatt HP5/3 (Germany).– Edition July 1989



ISONIC 2006 uniquely combines functionality and mobility of high performance portable digital ultrasonic flaw detector with recording, imaging, and data processing capabilities of smart computerized inspection system

Conventional pulse echo and through transmission A-Scan-based inspection

- 640X480 pixels A-Scan display with physical dimensions 130 x 92 mm (5.12" x 3.62") of working area is largest one for the plurality
 of portable ultrasonic flaw detectors
- Combined adjustable spike wave / square wave pulser equipped with variety of probe impedance matching coils provides optimal
 ultrasound penetration for various materials characterized either by high or low grain, sound attenuation, and the like
- High frequency probe may not be destroyed occasionally upon connecting to instrument's firing output even if duration of square wave initial pulse is improperly long thanks to probe damage prevention circuit automatically limiting energy transmitted to probe's crystal
- 46 dB dynamic range 20 dB/µs maximum slope multiple curve DAC/TCG may be created using up to 40 data points to correct distance

 amplitude variations of ultrasonic signals
- Both theoretical and experimental DAC may be activated either through keing in dB/mm (dB/") factor or through sequential recording echo amplitudes from variously located equal reflectors
- DAC/TCG may be applied to rectified A-Scans (positive, negative, and full wave) and to RF A-Scans as well
- Built-in DGS library for standard probes is unlimitedly expandable
- Thanks to extended dynamic range signals significantly exceeding A-Scan height (up to 199.9%) may be evaluated without drop of instrument Gain
- Whilst A-Scan is frozen managing of Gain and Gates settings is still allowed and provides bringing signals to necessary evaluation level and performing required evaluation
- Dual Ultrasound Velocity Measurement Mode extremely simplifies resolving of sound path distances for dissimilar materials adjacent to each other whereas different values of ultrasound velocity are valid for corresponding signals appearing on the same A-Scan
- RF display mode combined with frequency domain signal analysis enhances capabilities of the instrument for materials characterization, bond inspection, testing of dissimilar materials, defect pattern analysis, and probes evaluation
- Optional data logger organizes and manages database files capable to store up to 254745 thickness readings each and organized as 2D matrix. In database every thickness reading is accompanied with corresponding raw data A-Scan and instrument setup. Automatic creating of MS Excel[®] thickness spreadsheet meets requirements of various *Risk Based Inspection and Maintenance* (RBIM) procedures
- And more... see the technical data page



Thickness Profile imaging and recording is performed through continuous capturing of thickness readings along probe trace:

- Both time-based (real time clock) and true-to-location (built-in incremental encoder interface) modes of data recording are supported
- Complete sequence of A-Scans is recorded along with thickness profile
- Off-line evaluation of thickness profile record is featured with:
 - Sizing of thickness damages at any location along stored image: remaining thickness, thickness loss, and length of damage
 - Play-back and evaluation of A-Scans obtained during scanning
 - Reconstruction of thickness profile image for various Gain and/or Gate setings
 - Automatic conversion of thickness profile B-Scan data into MS Excel[®] thickness spreadsheet meeting requirements of

various *Risk Based Inspection and Maintenance* (RBIM) procedures Typical Application: Corrosion detection and characterization

B-Scan cross-sectional imaging and recording of defects for longitudinal and shear wave inspection is performed through continuous measuring of echo amplitudes and reflectors coordinates along probe trace:

- Both time-based (real time clock) and true-to-location (built-in incremental encoder interface) modes of data recording are supported
- Complete sequence of A-Scans is recorded along with B-Scan defects images
- Off-line evaluation of B-Scan record is featured with:
 - Sizing of defects at any location along stored image coordinates and projection dimensions
 - Play-back and evaluation of A-Scans obtained during scanning
 - Defects outlining and echo-dynamic pattern analysis
 - □ Reconstruction of B-Scan defects images for various Gain and/or Reject settings
 - DAC / DGS B-Scan normalization

Typical Applications: Pulse echo inspection of welds, composites, metals, plastics, and the like







On-Line

Off-Line

CB-Scan horizontal plane-view imaging and recording of defects for shear, surface, and guided wave inspection is performed through continuous measuring of echo amplitudes and reflectors coordinates along probe trace:

- Both time-based (real t) and true-to-location (built-in incremental encoder interface) modes of data recording are supported
- Complete sequence of A-Scans is recorded along with CB-Scan defects images
- Off-line evaluation of CB-Scan record is featured with:
 - Sizing of defects at any location along stored image coordinates and projection dimesions
 - Play-back and evaluation of A-Scans obtained during scanning
 - Defects outlining and echo-dynamic pattern analysis

Reconstruction of CB-Scan defects images for various Gain and/or Reject settings

DAC/DGS CB-Scan normalization

Typical Applications: Long range pulse echo and CHIME inspection of annular plates and pipes for pitting, stress corrosion, etc; weld inspection, surface wave inspection

TOFD Inspection – RF B-Scan and D-Scan Imaging:

- Both time-based (real time clock) and true-to-location (built-in incremental encoder interface and mechanics free airborne ultrasound encoder) modes of data recording are supported
- Averaging A-Scans whilst recording as per operator's selection
- Complete sequence of RF A-Scans is recorded along with TOFD map
- Off-line evaluation of TOFD Map is featured with:
 - Improvement of near to surface resolution through removal of lateral wave and/or back echo record
 - Linearization and straightening
- Play-back and analysis of A-Scans obtained during scanning
- Increasing contrast of TOFD images through varying Gain setting and/or rectification
- Defects pattern analysis and sizing
- Zoom of TOFD Map and A-Scans
- Typical Applications: weld inspection; CHIME inspection



2

Corrosion (thickness) mapping is performed through continuous capturing of wall thickness readings during XY scanning:

- True-to-location data recording is provided through mechanics free airborne ultrasound determining of probe location on planar and curved surfaces
- ٠ Complete sequence of A-Scans is recorded along with real time back wall surface rendering
- Off-line evaluation of captured XY wall thickness and A-Scan distribution data is featured with
- Sizing of thickness damages at any location of scanned surface: remaining thickness, thickness loss, XY dimensions, and area of damage
- Play-back and evaluation of A-Scans obtained during scanning
- Back wall surface profile reconstruction for various Gain and/or Gate settings
- Statistical analysis of XY wall thickness distribution data and its automatic conversion into MS Excel" spreadsheet meeting requirements of various *Risk Based Inspection and Maintenance* (RBIM) procedures



ISONIC On-Line Imaging by Dr.G

8 0 mm

×

Globa

Back [ESC]

Gmr

=7mm 8mm

=10n

=11m =12m =13mi

=14r

Exit [4]

=12r =13m

=14m

End

70

Q m In [3]

Side

Clear 121

On-Line

D=13.03 mm



Straight beam inspection with 3D data presentation (B-, C-, and D-Scan) is performed through continuous measuring and recording of echo amplitudes and reflectors coordinates during XY scanning:

- True-to-location data recording is provided through mechanics free airborne ultrasound determining of probe location on planar and curved surfaces
- Complete sequence of A-Scans is recorded along with real time B-, C-, and D-Scan imaging
- Off-line evaluation of captured B-, C-, and D-Scan images and A-Scan distribution data is featured with
 - Sizing of defects at any location of scanned volume: coordinates, XY projection dimensions, and area
 - Play-back and evaluation of A-Scans obtained during scanning; echo-dynamic pattern analysis
 - B-, C-, and D-Scan image reconstruction for various Gain and/or Gate and/or Reject settings
 - □ Slicing of C-Scan and D-Scan images
 - Statistical analysis of B-, C-, and D-Scan image and its automatic conversion into MS Excel[®] spreadsheet meeting requirements of various Risk Based Inspection and Maintenance (RBIM) procedures

Typical Applications: Flaw detection and imaging in metals, composites, plastics, and the like; corrosion detection and characterization

On-Line





ШÜ



Angle beam inspection with 3D data presentation (P-, D-, and B-Scan) is performed through continuous measuring and recording of echo amplitudes, reflectors coordinates, and probe swiveling angle during XY scanning:

- True-to-location data recording is provided through mechanics free airborne ultrasound determining of probe location and swiveling angle on planar and curved surfaces
- Complete sequence of A-Scans is recorded along with real time P-, D-, and B-Scan imaging
- Off-line evaluation of captured P-, D-, and B-Scan images and A-Scan distribution data is featured with:
- Sizing of defects at any location of scanned volume: coordinates, XY projection dimensions, and area
- Play-back and evaluation of A-Scans obtained during scanning; echo-dynamic pattern analysis
- P-, D-, and B-Scan image reconstruction for various Gain and/or Reject settings
- Slicing of P-Scan and D-Scan images

Typical Application: Weld and base metal angle beam inspection





CB-Scan imaging of volume under test aside of narrow scanning area is performed through continuous measuring and recording of echo amplitudes, reflectors coordinates, and probe swiveling angle during XY probe manipulating:

- True-to-location data recording is provided through mechanics free airborne ultrasound determining of probe location and swiveling angle
- Complete sequence of A-Scans is recorded along with real time CB-Scan imaging
- Off-line evaluation of captured CB-Scan images and A-Scan distribution data is featured with
 - Sizing of defects at any location of scanned volume: coordinates, XY projection dimensions, and area
 - Play-back and evaluation of A-Scans obtained during scanning; echodynamic pattern analysis
 - CB-Scan image reconstruction for various Gain and /or Reject settings

Typical Application: Flaw detection and corrosion screening using guided and surface waves; defect outlining using angle beam probes

On-Line







ISONIC 2006 – Technical Data

Pulse Type: Initial Transition: Pulse Amplitude:

Pulse Duration:

Energy (Spike Pulse): Modes: Damping Internal Matching Coil - Probe Impedance Matching: PRF: Optional Sync Output / Input: Gain: Advanced Low Noise Design: Frequency Band: Ultrasound Velocity: Range: Display Delay: Probe Angle: Probe Delay: **Display Modes:** Reject: DAC / TCG:

DGS: Gates Gate Start and Width:

Gate Threshold: Measuring Functions - Digital Display Readout:

Freeze Mode (A-Scans and Spectrum Graphs):

Encoding:

Airborne Ultrasound **Encoding Characteristics:** Straight Line Scanning:

True-to-location (incremental encoder – 0.5 mm resolution) XY Scanning: Airborne Ultrasound (see below)

Area of probe manipulation:	≤2000×3000 mm / ≤80×120 "	≤500×500 mm / ≤20×20 "	<mark>≤200×200 mm /</mark> ≤8×8 "
Curvature radius of scanning surface:	≥2000 mm / ≥40 "	≥200 mm / ≥8 "	≥37 mm / ≥1.5 "
Scanning Speed:	≤150 mm/s / ≤6 "/s	≤150 mm/s / ≤6 "/s	≤150 mm/s / ≤6 "/s
Scan Index:	1 to 20 mm controllable	1 to 20 mm controllable	0.25 mm; 0.5 mm or 1 to
	in 1 mm step	in 1 mm step	20 mm controllable in 1
	in thin stop	in thin ctop	mm step
Resolution for determining of probe coordinates: Resolution for determining of probe	≥1 mm / ≥0.04 "	≥1 mm / ≥0.04 "	≥0.25 mm / ≥0.01 "
swiveling angle:		1°	0.5°
Range of probe swiveling: Immunity to		±90°	±90°
ambient noise:	<60 dB	≤60 dB	<60 dB

Coupling Monitor:

Built-in controller and interface for Coupling Monitor suitable for any kind of ultrasonic probe at scanning speed up to 150 mm /sec (6 in /sec); resolution - 0.5 dB

frozen signals

Time-based (built-in real time clock - 0.02 sec resolution)

Positive Spike Pulse / Positive Square Wave Pulse

Square wave pulse - smoothly tunable (18 levels) 50...400 V into 50 Ω

Spike pulse - 10...70 ns for 50 Ω load depending on Energy and Damping setup

≤5 ns (10-90%)

edge of the pulse

4 discrete energy values / 40 µJ (min) to 250 µJ (max) Single / Dual 17 discrete resistances values / 25 Ω min to 1000 Ω max 16 discrete inductivity values / 2 µH min to 78 µH max 0 Hz - optionally; 0...5000 Hz controllable in 1 Hz resolution Max +5V, $\tau \le 5$ ns, t ≥100 ns, Load Impedance ≥ 50 Ω 0...120 dB controllable in 0.5 dB resolution 93 µV peak to peak input referred to 80 dB gain / 35 MHz bandwidth 0.35...35 MHz Wide Band / 34 Sub Bands 300...20000 m/s (11.81...787.4 "/ms) controllable in 1 m/s (0.1 "/ms) resolution 0.5...3000 µs - controllable in 0.01 µs resolution 0....3200 μ s - controllable in 0.01 μ s resolution 0...90° controllable in 1° resolution 0...70 µs controllable in 0.01µs resolution - expandable RF, Rectified (Full Wave / Negative or Positive Half Wave), Signal's Spectrum (FFT) 0...99 % of screen height controllable in 1% resolution Theoretical - through keying in dB/mm (dB/") factor Experimental - through sequential recording echo amplitudes from variously located equal reflectors 46 dB Dynamic Range, Slope \leq 20 dB/µs, Capacity \leq 40 points Available for Rectified and RF Display Standard Library for 18 probes / unlimitedly expandable 2 Independent Gates / unlimitedly expandable Controllable over whole variety of A-Scan Display Delay and A-Scan Range settings in 0.1 mm /// 0.001" resolution 5...95% of the A-Scan height controllable in 1% resolution

Spike pulse - smoothly tunable (18 levels) 50...400 V into 50 Ω at 4 levels of Excitation Energy

Square wave pulse - 65...600 ns controllable in 5 ns step with driving of both leading edge and trailing

27 automatic functions / expandable; Dual Ultrasound Velocity Measurement Mode for Multi-Layer Structures; Curved Surface/Thickness/Skip correction for angle beam probes; Ultrasound Velocity and Probe Delay Auto-Calibration for all types of probes

Freeze All

Freeze Peak All signal and spectrum evaluation functions, managing Gates and Gain settings are allowed for

Testing Integrity Monitoring:

Background imaging of Scanning Plan Recording and imaging of Actual Probe Trace Generating perceptible marks corresponding to coupling degree, probe position, and swiveling angle during scanning Interrupting of recording and imaging on missing coupling and/or probe position and/or swiveling angle

Imaging Modes:

Thickness Profile B-Scan, Cross-sectional B-Scan, Plane View CB-Scan, C-Scan, D-Scan, P-Scan, TOFD - depending on mode of operation selected accompanied with corresponding instrument settings

	Carrie Carl			
Imaging Characteristics:	Inspection:	Angle Beam	Straight Beam	
L'entre and a second			and the second second	
	Width of Volume			
	under test:	5 to 300 mm controllable in 1 mm	50 to 2000 mm controllable in 1 mm	
	B B B	resolution – expandable // 0.2 to 12 " controllable in 0.01 "	resolution – expandable /// 0.2 to 80 " controllable in 0.01 "	
	Children Children	resolution - expandable	resolution – expandable	
	Thickness of Volume		resolution expandable	
	under test:	5 to 300 mm controllable in 1 mm	0.5 to 300 mm controllable in 0.1 mm	
		resolution – expandable ///	resolution – expandable ///	
		0.2 to 12 " controllable in 0.01 "	0.02 to 12 " controllable in 0.01 "	
		resolution - expandable	resolution - expandable	
	Image Deschutions		0.2 mm 0.5 mm 0.5 Secondarday	
	Image Resolution:	0.5 mm × 0.5 mm × 0.5•ScanIndex 0.02 " × 0.02 " × 0.5•ScanIndex	0.2 mm × 0.5 mm × 0.5•ScanIndex 0.01 " × 0.02 " × 0.5•ScanIndex	
		0.02 × 0.02 × 0.3-3canindex		
	and the second se			
	Standard Color Scale			
	(Palette):	Pseudo Color	Pseudo Color	
		Gray	Gray	
		Thermal	Thermal	
	User Defined Color	032	o ³² I	
	Scales (Palettes):	≤2 ³² colors	≤2 ³² colors	
	Signal Amplitude Coloring Protocol:	Linear	Linear	
	coloring Protocol.	TCG Normalizing	TCG Normalizing	
		DAC Normalizing	DAC Normalizing	
		DGS Normalizing	Customized	
		Customized		
Length of one Straight Line				
Scanning record:		0"), automatic scrolling		
Method of Record:	Complete raw data rec			
Region of Interest:		e Display Delay, Probe Delay, Range,	US Velocity and other appropriate	
	instrument settings Recovery and play back of A-Scans captured during scanning			
Off-Line Analysis:				
	Echo-dynamic pattern analysis			
	Defects sizing and outlining Statistical analysis of Thickness / Amplitude data			
Converting record into ASCII / MS Excel [®] / MS Word [®] formation				
Data Reporting: Direct printout of Calibration Dumps, A- cross-sectional B-Scans, plane view CE				
		cluding calibration dumps accompanied with A-Scans and/or Spectrum		
Bata otorago capacity.	Graphs	iona ang banbration aampo abbompan		
~	At least 10000 sets including calibration dumps accompanied with thickness profile		ed with thickness profile	
			Scans, D-Scans, P-Scans, TOFD maps	
	and complete sequence of A-Scans captured during scanning			
Data Logger:	ata Logger: Optional - creates and manages data base files capable to store up to 254745 records each and organized as 2D matrix; in database every record includes thickness reading accompanied with			
2 2 1				
E		ta A-Scan and instrument setup		
On-Board Computer:	Computer: AMD LX 800 - 500MHz			
RAM:	512 Megabytes			
Flash Memory - Quasi HDD:	4 Gigabytes			
Outputs:	LAN, USB X 2, PS 2, SVGA			
Outputs: Screen:	6.5" High Color Resolution (32 bit) SVGA 640x480 pixels 133x98 mm (5.24" x 3.86") Sun-readable			
		D; Maximal A-Scan Size (working area) - 130x92 mm (5.12" x 3.62")		
Controls:	Front Panel Sealed Keyboard, Front Panel Sealed Mouse, Touch Screen PS 2 Keyboard and Mouse, USB Keyboard and Mouse, USB Flash Memory card, Printer			
Compatibility with the external devices:				
Operating System:	through USB or LAN, PC USB or LAN, SVGA External Monitor Windows™XP Embedded			
Power:	Windows [™] XP Embedded Mains - 100240 VAC, 4070 Hz, auto-switch; Battery 12V 8AH up to 6 hours continuous operation			
Housing:	IP 53 rugged aluminum case with carrying handle			
Dimensions:	265×156×121 mm (10.43"×6.14"×4.76") - without battery			
Dimonolono.		3"×6.14"×6.26") - with battery		
Weight:	3,150 kg (6,93 lbs) - wi			
	4.280 kg (9.42 lbs) - wi			
	,	A CONTRACT OF A		